MOSFET – Power, Single, N-Channel, SOT-23, 2.4 x 2.9 x 1.0 mm

20 V, 3.6 A

Features

- Advanced Trench Technology
- Ultra-Low R_{DS(on)} in SOT-23 Package
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Power Load Switch
- Power Management

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

Parameter Symbol Value Unit								
Parame	Parameter							
Drain-to-Source Voltage	V _{DSS}	20	V					
Gate-to-Source Voltage	V _{GS}	±8	V					
Continuous Drain Current	······································				А			
(Note 1)	State T _A = 85°C			2.6				
	$t \leq 5 \ s \qquad T_A = 25^\circ C$			6.5				
Power Dissipation (Note 1)	Steady T _A = 25°C State		P _D	0.47	W			
	t ≤ 5 s			1.56				
Pulsed Drain Current	t _p =	10 μs	I _{DM}	13.2	А			
Operating Junction and Sto	T _J , T _{STG}	–55 to 150	°C					
Source Current (Body Diod	۱ _S	2.2	А					
Lead Temperature for Sold (1/8 in from case for 10 s)	ering Purp	oses	ΤL	260	°C			

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	264	°C/W
Junction-to-Ambient – t \leq 5 s (Note 1)	$R_{\theta JA}$	80	

Surface-mounted on FR4 board using 1 in sq. pad size 1. (Cu area = 1.127 in sq. [1 oz] including traces).

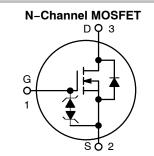
2. Pulse Test: pulse width \leq 300 ms, duty cycle \leq 2%.

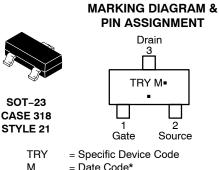


ON Semiconductor®

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V _{(BR)DSS}	R _{DS(on)} Max	I _D MAX
	24 mΩ @ 4.5 V	
20 V	26 mΩ @ 3.7 V	
	29 mΩ @ 3.3 V	3.6 A
	33 mΩ @ 2.5 V	
	55 mΩ @ 1.8 V	





= Date Code*

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= Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
NTR3C21NZT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel
NTR3C21NZT3G	SOT-23 (Pb-Free)	10,000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T₁ = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_{D} = 250 μ A		20			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	$I_D = 250 \ \mu A$, ref to $25^{\circ}C$			21.6		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, T _J = 25°C				1.0	μΑ
		$V_{DS} = 20 V$	$T_J = 85^{\circ}C$			5.0	μΑ
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS}$	₆ = ±8 V			±10	μA
ON CHARACTERISTICS (Note 3)					-		
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS}=V_{DS},I_{D}=250\;\mu A$		0.45		1.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				2.7		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 4.5 V	I _D = 5 A		18	24	mΩ
		V _{GS} = 3.7 V	I _D = 4 A		18.5	26	
		V _{GS} = 3.3 V	I _D = 3 A		19	29	
		V _{GS} = 2.5 V	I _D = 2 A		20	33	
		V _{GS} = 1.8 V	I _D = 1 A		25	55	
Forward Transconductance	9FS	$V_{DS} = 5 V, I_{D}$	= 3 A		20		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{iss}				1540		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 16 V			105		1
Reverse Transfer Capacitance	C _{rss}	1			86		1
Total Gate Charge	Q _{G(TOT)}				17.8		nC
Threshold Gate Charge	Осты	1			2.1		1

SWITCHING CHARACTERISTICS (Note 4)							
Gate-to-Drain Charge	Q_{GD}			0.8			
Gate-to-Source Charge	Q _{GS}	$v_{GS} = 4.5 v, v_{DS} = 10 v, I_D = 5 A$		3.0			
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 16 V, I _D = 5 A		2.1			

Fall Time	t _f			4670				
Turn-Off Delay Time	t _{d(off)}	$I_{\rm D} = 5 {\rm A}, {\rm R}_{\rm G} = 6.0 {\Omega}$		420				
Rise Time	t _r	V _{GS} = 4.5 V, V _{DS} = 16 V,		14				
Turn-On Delay Time	t _{d(on)}			7.0		ns		

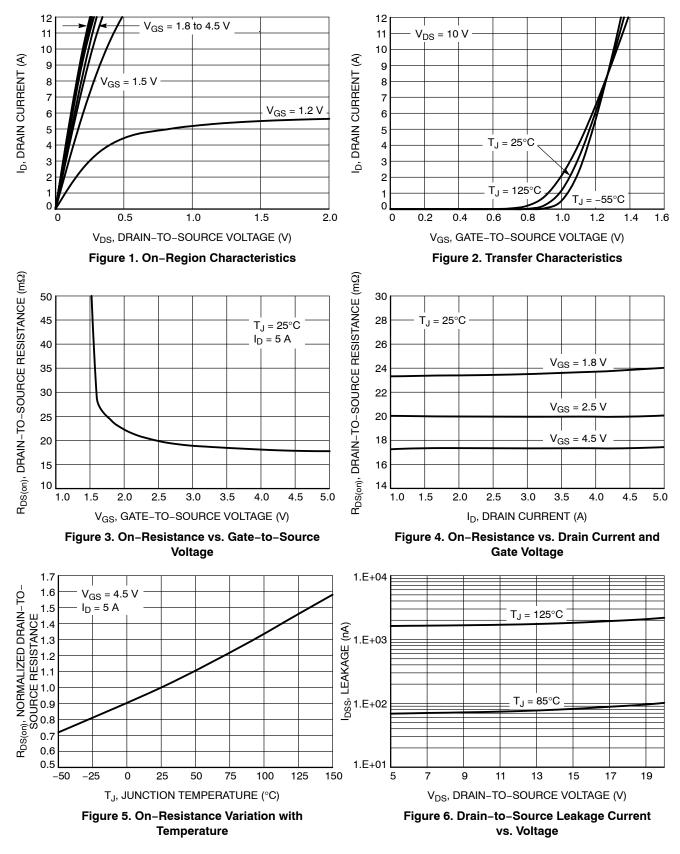
DRAIN-SOURCE DIODE CHARACTERISTICS

Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$	0.7	1.0	V
		I _S = 2.0 A	T _J = 125°C	0.56		

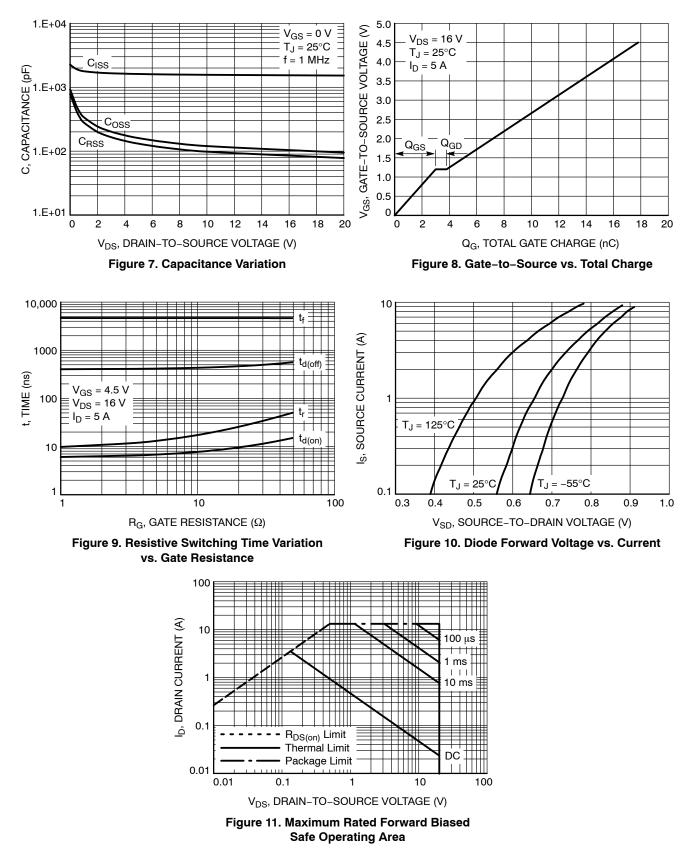
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Pulse Test: pulse width \leq 300 ms, duty cycle \leq 2%.

4. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

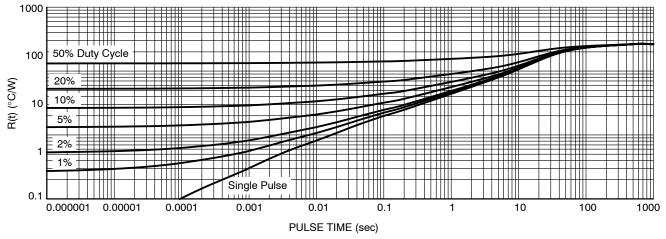
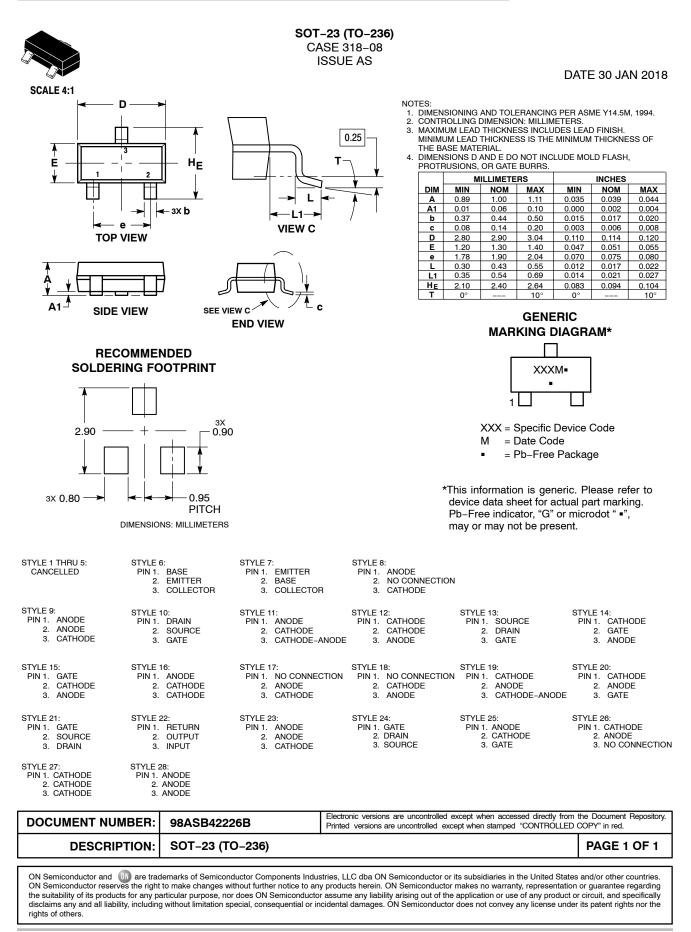


Figure 12. FET Thermal Response





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